Plan for the Characterization of HIRF Effects on a Fault-Tolerant Computer Communication System

Wilfredo Torres-Pomales, Mahyar R. Malekpour, Paul S. Miner, and Sandra V. Koppen
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Abstract

This report presents the plan for the characterization of the effects of high intensity radiated fields on a prototype implementation of a fault-tolerant computer communication system. Various configurations of the communication system will be tested. The prototype system is implemented using off-the-shelf devices. The system will be tested in a closed-loop configuration with extensive real-time monitoring. This test is intended to generate data suitable for the design of avionics health management systems, as well as redundancy management mechanisms and policies for robust distributed processing architectures.
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1. Overview

One of the objectives of the Integrated Vehicle Health Management (IVHM) project of NASA’s Aviation Safety Program is to develop failure databases and test capabilities suitable for use in the creation of advanced health-management systems. Safety, cost and performance are addressed as part of this IVHM objective. The IVHM project is also investigating mitigation techniques for failures of avionics systems caused by environmental threats, including electromagnetic interference (EMI) from sources such as lightning and high-intensity radiated electromagnetic fields (HIRF). These environments are of interest because of the potential to cause unexpected and seemingly arbitrary fault manifestations in individual avionics system components, as well as generating simultaneous common-mode faults that can overwhelm current system redundancy management approaches [1, 2]. Among the key challenges of the IVHM project is the development of enabling technologies for the design of large-scale robust and reliable distributed processing architectures for vehicle-wide health assessment and management functions. The work presented here is part of an effort to meet this challenge by focusing on scalable architectural solutions and complementary customizable redundancy management strategies, including fault detection, diagnosis and reconfiguration elements, to meet a wide-range of performance and dependability requirements.

The chosen first step in that direction is to assess the robustness of an existing distributed system by exposing it to severe faults caused by environmental disturbances. This report presents a plan for the generation of data suitable for a first-order characterization of the response of an electronic system experiencing faults. In this fault-injection test, the function of specific targeted devices is disrupted by immersing the devices in a controlled HIRF environment. The tests are performed while the devices operate in a closed-loop configuration and are monitored from a protected location. The system selected for this test is an open-source-based prototype of the communication system of the Scalable Processor-Independent Design for Extended Reliability (SPIDER) architecture concept developed at Langley Research Center (LaRC) under a previous project [3]. This type of platform is essential for this test over proprietary systems because proprietary systems typically provide little or no visibility into their internal operations and tend to be difficult and costly to instrument. Additionally, when proprietary systems are used, the experimental data and analysis results normally cannot be openly shared with the wider research community, thus limiting the potential benefit of the test.

SPIDER is a concept for a family of general-purpose fault-tolerant processing architectures that provides a flexible set of architectural solutions capable of satisfying a wide range of performance and reliability requirements, while preserving a consistent interface to applications. The SPIDER architecture consists of processing elements (PEs) executing the applications and high-level system functions, and the Reliable Optical Bus (ROBUS) data communication system, which provides guaranteed basic services that support PE-level services. The goals of the ROBUS design are to reduce the computational burden on the processing elements, to implement the basic distributed protocols in the way they are most effective (i.e., in hardware), and to provide a simple system abstraction to the PEs for what is an inherently complex distributed processing problem. ROBUS-2, an instance of ROBUS, is a time-division multiple access (TDMA) broadcast data communication system (i.e., a data bus) with medium access control by means of a time-indexed communication schedule. ROBUS-2 provides guaranteed fault-tolerant services to the attached PEs in the presence of a bounded number of internal faults. These services include message broadcast (Byzantine Agreement), dynamic communication schedule update, time reference (clock synchronization), and distributed diagnosis (group membership). ROBUS-2 also features fault-tolerant startup and restart capabilities. ROBUS-2 tolerates internal as well as PE faults, and incorporates a dynamic self-reconfiguration capability driven by the internal diagnostic system. ROBUS-2 consists of custom-designed hardware-based ROBUS Protocol Processors (RPPs).
implementing the ROBUS-2 functionality, and a lower-level physical communication network interconnecting the RPPs. A COTS-based laboratory prototype implementation of ROBUS-2 will be used for this test. Additional information about ROBUS-2 can be found in [4] and [5]. The source code for the ROBUS-2 RPP is publicly available under an open-source license agreement on the Internet at [8].

The objective of the test described here is to characterize the effect of a HIRF environment on the behavior of the ROBUS-2 system and its components. Different system configurations will be tested with variations on the communication data rate, the degree of redundancy, and the number of targeted system components. The characterization will consider the effects at the interfaces to the PEs, at the interfaces of internal system components, and on the state of the communication system. Of special interest is determining the severity of component faults and assessing the robustness of the system to multiple simultaneous faults. We would like to identify weaknesses in the design of ROBUS-2 and desirable features for more robust communication systems. The test results will also contribute to the development of redundancy management mechanisms and policies for robust processing architectures.

2. Test Articles

Figure 1 shows the ROBUS topology. The bus has a redundant active-star architecture with the Bus Interface Units (BIUs) serving as the bus access ports, and the Redundancy Management Units (RMUs) providing connectivity as network hubs. The network between BIUs and RMUs forms a complete bipartite graph in which each node is directly connected to every node of the opposite kind. All the communication links are bidirectional.

At the interface to the PEs, ROBUS behaves as a shared-medium communication bus with a time-division multiple access (TDMA) channel access pattern. Thus, one way of viewing ROBUS is as a distributed fault-tolerant communication hub.

2.1. Functional Systems

Three different ROBUS configurations will be used in this test: a 4x2 system (i.e., with 4 BIUs and 2 RMUs), a 4x3 system, and a 4x4 system. Figure 2 illustrates these configurations. The ROBUS 4x2 system has two independent communication paths between every pair of BIUs and can tolerate at most one faulty RMU at any given time. The ROBUS 4x3 system has three independent paths between every
pair of BIUs and can tolerate one arbitrarily faulty active RMU, and no more than two simultaneously faulty RMUs. The ROBUS 4x4 system has four independent paths between every pair of BIUs. A 4x4 configuration can tolerate one active arbitrarily faulty RMU, two arbitrarily faulty RMUs if one of them has been diagnosed (and thus isolated from the rest of the system), and no more than three simultaneously faulty RMUs. The ROBUS 4x2, ROBUS 4x3 and ROBUS 4x4 systems can tolerate the same number of faulty BIUs. To enable the performance of some useful work at the PEs, at least two PEs must be able to communicate with each other. A ROBUS system with at least two properly working BIUs can tolerate one active arbitrarily faulty BIU, and no more that two arbitrarily faulty BIUs if one of them has been diagnosed. Each communication system will be tested while interacting with four independent PEs. The three ROBUS configurations are tolerant to faults at the PEs and at the links between the PEs and the communication system.

Figure 2: ROBUS Configurations

A simplex (i.e., non-redundant) hub will also be used in this test. The hub is functionally equivalent to ROBUS at the interface to the PEs. This system will serve as a reference to assess the effectiveness in a HIRF environment of ROBUS with its current redundancy management design. Figure 3 shows the topology of the communication system with the simplex hub.

Figure 3: Simple Hub Configuration
2.2. Physical Device

The reconfigurable SPIDER prototyping platform (RSPP) developed for NASA by Derivation Systems, Inc. (DSI) under a phase III SBIR contract will be used to implement the communication systems to be tested. The RSPP is a Field Programmable Gate Array (FPGA) based development system for the design and testing of SPIDER prototypes. The architecture is a scalable modular system composed of individual RSPP nodes interconnected with point-to-point fiber optic links. An RSPP node is a PC/104-plus computer system consisting of the following hardware components.

- **PF3100-2V3000 PC/104+ FPGA Module**: PF3100 with the Xilinx Virtex-II XC2V3000 (3 million gate) FPGA.
- **PFBR104 PC/104 Fiber Optic Transceiver Module**: Interfaces with the PF3100 over the PF3100 IO connector and provides four Agilent HFBR-5905 fiber optic transceivers. Each RSPP node has two PFBR104 modules providing a total of 8 fiber optic IO channels.
- **PC/104+ CPU Module**: The PC/104+ CPU module is a Lippert CRR2 with a 300MHz Pentium class processor, 64MB SDRAM, 256MB Compact Flash, 10/100 Ethernet, VGA, Keyboard, RS232 serial port, parallel port, USB port, and cables. The White Dwarf Linux operating system is installed on the CPU module.
- **PC/104 Power Supply**: A 75 Watt, DC-DC 10A PC/104 power supply is used to provide conditioned power to the internal electrical components of the RSPP node.
- **PC/104 Fan Module**: A fan module provides airflow inside the enclosure to provide cooling of the internal components by providing even heat distribution to avoid hot-spots.
- **PC/104 Enclosure**: A PC/104 enclosure is used to provide packaging as well as EMI shielding for the RSPP node electrical components. The enclosure is made from high-grade extruded aluminum and incorporates a railed card cage subassembly for the electronic components. Endcaps on either end of the enclosure provide access to the internal components, and are machined with cutouts for the various connectors on the RSPP node. Standard PC ports including video, keyboard, mouse, serial, parallel, USB, Ethernet, and power are provided. In addition, eight fiber optic bulkhead adapters are fitted on the endcaps to provide the maximum number of fiber optic channels that can be configured on a single RSPP node.

Figure 4 shows two views of an RSPP node. Each node requires 24 V DC input power and has a 15-ft. power cable with the shield attached to the connectors at both ends. The enclosure is grounded through the power cable shield. The RSPP nodes do not require external cooling. Fiber optic cables of 60 meters (196 feet) in length (to approximate the length of wiring in actual aircraft installations) are used for point-to-point data communication between nodes. For this test, the BIUs, RMUs, and the simplex hub will be implemented on separate RSPP nodes. The four PEs will be implemented on one RSPP node as independent hardware functions.

3. System Monitoring

The communication systems to be tested operate at a 300 Hz cycle rate. In normal operation, with no
faults, each system will process exactly the same data, execute exactly the same operations, and produce exactly the same results in each cycle. This fact will be leveraged in the system monitoring functions. Each system will be monitored in real-time by the PEs and by embedded observers that collect state data from the nodes and relay it to remote monitors. In addition, the messages transmitted by a selected BIU or RMU will be monitored during some of the tests of the ROBUS 4x4 system.

The Processing Elements (PEs) designed for this test serve four functions. First, a PE emulates the behavior of a real processor in its interaction with the communication system. A PE synchronizes and tracks the state of the BIU (or the simplex hub) to ensure proper communication between the two. In normal operation, the communication between the PEs and the bus is time-triggered and highly deterministic. Second, a PE performs error detection on the communication observed at its respective bus interface port. Each PE sends the same messages over the bus during each cycle and checks each received message for timing and content. Third, the PEs forward their observations to a common bus analyzer (see HFA below). Fourth, during each cycle each PE builds a record of its status and observations that is then used for overall system health monitoring (see SHM below) and post-test analysis.

The Hub Fault Analyzer (HFA) combines the observations from the four PEs to assess the behavior of the communication system in real-time. The HFA classifies each observation per the categories of a hybrid fault model based on error detection, symmetry, and correctness of received messages. At the end of each communication system cycle, the HFA outputs a record with the results for the cycle. This record is used for overall system health monitoring (see SHM below) and post-test analysis.

The Node Monitors record the state of communication system nodes (BIUs, RMUs, or simplex hub). Each time a node makes a Minor Mode transition (see [4]), a record is generated containing the
operational mode, current diagnostic results, and the status of each communication port. This record is used for overall system health monitoring (see SHM below) and post-test analysis.

The **Node Fault Analyzer** (NFA), used in some tests of the ROBUS 4x4 system, combines the observations from four nodes about a particular node of the opposite kind (i.e., four BIUs observing one RMU, or four RMUs observing one BIU) to assess the behavior of the observed node. The NFA uses the same classification functions as the HFA. At the end of each communication system cycle, the NFA outputs a record with the results for the cycle, which is then used for overall system health monitoring (see SHM below) and post-test analysis.

The **System Health Monitor** (SHM) is a generic monitoring function used for real-time assessment of the health of the communication system. Instances of this function are used with each PE, the HFA, each state monitor, and the NFA. Each SHM compares the data records generated by its corresponding function against the records expected during normal system operation and a system health assessment is made based on the timing and content of the records. Figure 5 shows the state transition graph for the SHM. After a reset, a good record (i.e., with expected content) must be received within the Startup Timeout delay, otherwise a system failure will be declared. When the first good record is received, the SHM transitions to the Recovery state, where it will remain until stable good operation is confirmed or a failure to return to normal operation is declared. The SHM will remain in the Trusted state as long as good records are generated by the monitored function.

![Figure 5: SHM State Transition Graph](image)

For this test, the SHM Startup Timeout is set to 30.0 seconds, the Recovery Timeout is set to 6.0 seconds, and the Stable Recovery timeout is set to 0.5 seconds.

The system monitoring functions will be implemented using two RSPP nodes referred to as the PE Emulator and the Bus Monitor. The **PE Emulator** includes the PEs, HFA, and NFA with their individual SHM modules. The **Bus Monitor** includes a state monitor with an SHM module for each communication system node. The PE Emulator and the Bus Monitor are also used for data collection.
4. HIRF Environment

The test articles will be subjected to a radiated susceptibility testing process. The process, based on RTCA/DO-160D guidelines [6], incorporates the use of a reverberation chamber (RC), RF measurement instrumentation, specialized control and data acquisition software, and the generation and use of calibration data. The test articles will be exposed to radiated electromagnetic (EM) fields from all sides.

4.1. Reverberation Chamber Description

A RC is an electrically conductive shielded enclosure used for generating an electromagnetic (EM) environment for radiated susceptibility and emissions testing. The operational concept is similar to a very large microwave oven. Theoretically, a reverberation chamber is modeled as a large cavity resonator characterized by three-dimensional stationary wave patterns (i.e., resonance modes) at resonant frequencies determined by the dimensions of the chamber. When a radiated field at a resonant frequency enters the cavity, it is reflected back and forth between the walls with low energy loss, and additional energy entering the cavity reinforces the standing wave and increases its intensity. This resonance phenomenon allows the generation of high intensity electromagnetic fields with relatively low input power. However, it has the disadvantage that the spatial distribution of the field is not homogeneous. In practice, a transmit antenna is used to emit RF energy inside the chamber setting up a complex field structure within the chamber. Rotating mechanical stirrers then “mix” the energy, effectively changing the boundary conditions and creating new complex field structures. When sampled over time, this stirring results in a statistically uniform and isotropic test environment.

Reverberation chambers can be operated as either mode-stirred or mode-tuned. During mode-stirring the stirrers continuously rotate at a set rate. Mode-tuning requires the stirrers to be incrementally stepped through a complete rotation with a set dwell time applied at each step. In either case, one complete stirrer rotation will result in environment test samples that are statistically isotropic, uniform, and randomly polarized. Therefore, the test articles are exposed to radiation from all aspect angles and polarizations, thus eliminating the need to move or rotate it. Mode-stirring was chosen for this application because it is easier to implement and significantly reduces test time.

A reverberation chamber is associated with a lowest usable frequency (LUF). The chamber size and geometry contribute to the generation of a sufficient number of modes to ensure adequate field mixing and uniformity. Generally, larger chambers have a lower LUF.

RCs offer several advantages, such as field uniformity and repeatability, the ability to generate high field levels efficiently with less power, reduced test time, and a screened environment with no ambient signals. Disadvantages include loss of polarization and directivity data, and some difficulty correlating time-critical susceptibilities with RF environment.

4.2. Test Facility

Testing will be conducted in the NASA LaRC High Intensity Radiated Fields (HIRF) Laboratory. Figure 6 is a diagram of the layout of the facility which consists of five separate steel chambers. Chambers A, B, and C are reverberation chambers used for radiated emissions and susceptibility testing. Chambers D and E are used as an Amplifier Room and Control Room, respectively. Figure 6 also shows the LUF for each of the chambers. The HIRF Lab chambers were characterized by the National Institute of Standards and Technology (NIST), and demonstrated to have a high level of field uniformity [7]. The facility has the capability to perform distributed testing using two or three of the co-located RCs, which
allows for the simultaneous testing of multiple system components by generating a different radiated environment in each chamber.

Chamber A will be used for this application because the frequency range and power requirements specified in the test plan easily fit within the facility’s capabilities. The HIRF Lab has the resources to operate Chamber A at frequencies up to 18 GHz and at field intensities up to 1500 V/m.

![Figure 6: NASA LaRC High Intensity Radiated Fields Laboratory](image)

**4.3. Measurement Method**

The HIRF Lab reverberation chamber will be operated and calibrated based on RTCA/DO-160D Change 1 guidelines, but with modifications to accommodate mode-stirring. A typical test configuration is illustrated in Figure 7 showing Chamber A, the Amplifier Room (D), the Control Room (E), and test equipment. RC calibration requires transmitting a known input power into the chamber with stirrers rotating. Some of the input power will be lost due to absorption by the chamber, test devices, and antennas. Receive power is measured with a spectrum analyzer in maximum-hold mode. The calibration factor is then determined from the ratio of the known input power to the peak measured receive power. To determine the chamber calibration factor (CF) the following calculation is used [6].

\[
CF_{(dB)} = 10 \log_{10} \left( \frac{8\pi L^2}{\lambda^2} \right) + P_{\text{MaxRec(dBm)}} - P_{\text{Input(dBm)}} \tag{1}
\]

where \(P_{\text{Input(dBm)}}\) denotes the known input power in units of dBm, \(P_{\text{MaxRec(dBm)}}\) is the measured maximum receive power in units of dBm over a complete stirrer rotation, and \(\lambda\) denotes the frequency wavelength. (A dB is a logarithmic measurement unit that expresses the magnitude of a physical quantity relative to a
reference level. The magnitude \( P \) of a quantity expressed in dB’s relative to magnitude \( r \) is defined as \( P_{\text{dB}} = 10 \cdot \log_{10}(P/r) \), where \( \log_{10}(\cdot) \) is the logarithm with base 10. A dBm is a unit of power in dB relative to 1 mW.)

Once the chamber calibration factor is known, a test input power can be calculated that will produce a required electric field level (V/m) inside the chamber using the following.

\[
P_{\text{Input(dBm)}} = 10 \cdot \log_{10}(E^2/377) + \text{CF}_{(\text{dB})} + 30 \text{ dB},
\]

where \( P_{\text{Input(dBm)}} \) denotes the input power in dBm at transmit antenna, \( E \) is the required electric field in V/m, and \( \text{CF}_{(\text{dB})} \) is the chamber calibration factor in dB.

As illustrated in Figure 7, forward power from the amplifier is measured using a power meter and peak power RF sensor connected to the forward port of the directional coupler. The input power at the antenna is then related to the measured forward power at the meter when corrected for cable losses (6c) and coupling factor.

---

**Figure 7:** Reverberation Chamber Test Setup illustrating Chamber A, Control Room (E), Amplifier Room (D), and Equipment.
The receive path is measured between the receive antenna and the spectrum analyzer and includes cables (7a, 7b & 7c) and a directional coupler (4a). Receive path losses and gains are applied to the maximum power measured at the spectrum analyzer to determine the maximum receive power at the receive antenna.

Measurements can be affected by uncertainties in the RC and the measurement instruments. NIST’s characterization of Chamber A [7] indicates uniformity uncertainties of +/- 4 dB at 100 MHz and +/-2 dB at frequencies of 200 MHz and above. Test instrumentation was calibrated to accuracies of +/- 2 dB for the spectrum analyzer, and 0.5 dB or less for the power meter and RF signal generator.

5. Test Specification

The design of ROBUS-2 is supported by formal fault-tolerance theoretical results and design analysis and is based on a set of assumptions about the number, timing and severity of manifestations of active faults [4]. The design of the system re-initialization strategy of ROBUS-2, which is triggered when the system experiences multiple coincident faults beyond the guaranteed-performance capacity of its fault handling mechanisms, is based on the assumption that such events can only be caused by rare external disturbances of known bounded duration. As the purpose of this test is to assess the robustness of the ROBUS-2 system, and given the highly deterministic (and thus uninteresting) behavior of ROBUS-2 when its timing design assumptions are satisfied, this test is deliberately specified such that the duration of the HIRF exposures are longer than assumed in the design of the system. Furthermore, the test specification takes advantage of the known fault-tolerance degree of ROBUS-2 to characterize the behavior of individual ROBUS nodes while operating in their normal system configuration with absolute certainty that the tested node will have no significant impact on the behavior of the rest of the system.

The test consists of two parts. The purpose of the first part, called the HIRF Susceptibility Threshold Characterization (HSTC), is to determine the change in the susceptibility threshold (i.e., the minimum field strength to cause an upset) of the RSPP nodes as a function of test frequency, the actual radiated physical node, the location of a node inside the test chamber, and the radiation pattern that a node is exposed to. The data from the HSTC will be used in the second part, called the HIRF Effects Characterization (HEC), to determine the range of field strengths and the set of frequencies for testing various hardware configurations to characterize the effects of the radiation on the targeted devices.

5.1. Hardware Configurations

Table 1 lists the hardware configurations available for this test. There will be two versions of each communication system: a low-speed version with a 3.2 Mbps (mega-bits per second) data rate, and a high-speed version at 12.8 Mbps. Testing versions with different data rates will serve to examine the dependence between the data rate and the response of the system to radiated fields. The ROBUS 4x2 and 4x3 systems use the same BIU and RMU implementations as the ROBUS 4x4 system. The only physical difference between these systems is the actual number of RMUs used. ROBUS-2 has the capability to automatically detect missing nodes and reconfigure its state accordingly.

Four ROBUS 4x4 system configurations will be available in which only one node is targeted. The purpose of these configurations is to characterize the node fault manifestations within ROBUS. Such data is important for the design of effective redundancy management strategies. These configurations will be the only ones using the NFA monitoring function.
Table 1: Available Hardware Configurations

<table>
<thead>
<tr>
<th>Hardware Configuration</th>
<th>Communication System</th>
<th>Data Transfer Rate</th>
<th>Radiated Components (Targets)</th>
</tr>
</thead>
<tbody>
<tr>
<td>HC1</td>
<td>Simplex Hub</td>
<td>Low</td>
<td>Hub</td>
</tr>
<tr>
<td>HC2</td>
<td>Simplex Hub</td>
<td>High</td>
<td>Hub</td>
</tr>
<tr>
<td>HC3</td>
<td>ROBUS 4x4</td>
<td>Low</td>
<td>RMU 1</td>
</tr>
<tr>
<td>HC4</td>
<td>ROBUS 4x4</td>
<td>Low</td>
<td>BIU 1</td>
</tr>
<tr>
<td>HC5</td>
<td>ROBUS 4x2</td>
<td>Low</td>
<td>RMU 1</td>
</tr>
<tr>
<td>HC6</td>
<td>ROBUS 4x4</td>
<td>High</td>
<td>RMU 1</td>
</tr>
<tr>
<td>HC7</td>
<td>ROBUS 4x4</td>
<td>High</td>
<td>BIU 1</td>
</tr>
<tr>
<td>HC8</td>
<td>ROBUS 4x2</td>
<td>High</td>
<td>RMU 1</td>
</tr>
<tr>
<td>HC9</td>
<td>ROBUS 4x2</td>
<td>Low</td>
<td>ROBUS 4x2</td>
</tr>
<tr>
<td>HC10</td>
<td>ROBUS 4x3</td>
<td>Low</td>
<td>ROBUS 4x3</td>
</tr>
<tr>
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<td>ROBUS 4x4</td>
<td>Low</td>
<td>ROBUS 4x4</td>
</tr>
<tr>
<td>HC12</td>
<td>ROBUS 4x2</td>
<td>High</td>
<td>ROBUS 4x2</td>
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<tr>
<td>HC13</td>
<td>ROBUS 4x3</td>
<td>High</td>
<td>ROBUS 4x3</td>
</tr>
<tr>
<td>HC14</td>
<td>ROBUS 4x4</td>
<td>High</td>
<td>ROBUS 4x4</td>
</tr>
</tbody>
</table>

The ROBUS 4x2 configurations with one targeted RMU are intended to characterize the response of the system when the number of non-faulty redundant components of a particular kind is reduced to the minimum.

The remaining configurations targeting the whole communication system in each case are meant to assess the relative effectiveness of the communication systems in handling HIRF-induced faults. For these configurations, their fault handling effectiveness will be assessed at the PE interfaces. Configurations of ROBUS 4x2, 4x3 and 4x4 systems can also be analyzed from the perspective of their internal state transitions in response to HIRF-induced faults.

5.2. Device Positions Inside The Test Chamber

Figure 8 shows the options for positioning devices inside the test chamber. The locations are identified by the numbers 1 through 8 as indicated. At each location there is a non-conductive foam block or table intended to support at most one RSPP node elevated above the chamber floor. The devices can be placed at these locations such that the distance between any two devices and between the devices and the stirrers, chamber walls, and antennas is at least one-half wavelength at the lowest test frequency (i.e., 1.5 meters at 100 MHz). This separation is intended to reduce the disturbance to the local radiation characteristics caused by other items inside the chamber.

5.3. Radiation Modulations

Various modulations to the chamber RF (radio frequency) input signal will be used in this test. The basic waveform is a continuous (i.e., unmodulated) wave (CW). Pulse modulation will consist of 20 µs pulses of the test frequency at a 1 kHz pulse rate. A square wave modulated input signal will have a modulation frequency of 1 kHz and a 50% duty cycle. The pulse and square modulations are defined taking into consideration the reverberation chamber time constant and wave modulation recommendations in [6].
Additionally, it is known that due to the reverberation and stirring of the field inside the test chamber, the targeted devices will experience position and time-dependent field amplitude modulations superimposed on the input RF signal modulation. For completeness, we intend to measure at one or more locations the magnitude of the peak field as a function of stirrer rotation angle.

5.4. HIRF Susceptibility Threshold Characterization

The HSTC is intended to characterize the dependence of the HIRF susceptibility threshold to variations in frequency, physical device, radiation modulation, and position within the test chamber. The HSTC consists of a series of tests as described in Table 2. Hardware configurations HC3 and HC4 will be used for these tests. For HC3 configuration tests, physical RSPP nodes 5 through 8 alternate to perform the targeted RMU1 function as indicated in Table 2. Likewise, for HC4 configuration tests, physical RSPP nodes 1 through 4 will be reprogrammed to perform the BIU 1 function as indicated.

For each test, the desired output is a graph indicating the minimum field strength to cause an upset for each test frequency. The 2-out-of-3 rule described in Section 5 will be used to identify the susceptibility threshold of the targeted device at a particular frequency. The test frequency range is 100 MHz to 1000 MHz with specific frequency values determined by the formula \( f_{n+1} = (10^{1/24}) f_n \) [6] for a total of 25 frequencies. At each HSTC test frequency, the calibrated peak electric field strength is swept starting at the lowest test field strength and increasing in steps of 20 V/m until the susceptibility threshold or the maximum field strength is reached. For tests with unspecified lowest test field strength in Table 2, the results from preceding tests will be used to determine an appropriate lowest level. Document [6] and recommendations from HIRF Lab personnel were considered in the specification of the field strength ranges. The stirrers will be set to rotate at 10 seconds per revolution. The dwell time at each tested frequency-and-field-strength point will be 30 seconds (i.e., 3 stirrer rotations). Each individual radiation exposure at a particular frequency and field strength is called a **round**.
### Table 2: Tests for HIRF Susceptibility Threshold Characterization

<table>
<thead>
<tr>
<th>HSTC Test Id</th>
<th>Hardware Configuration</th>
<th>Variable of Interest</th>
<th>ROBUS Node</th>
<th>Physical RSPP node</th>
<th>Position</th>
<th>Modulation</th>
<th>Field Range (V/m)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>HC3</td>
<td>Physical Node</td>
<td>RMU 1</td>
<td>5</td>
<td>5</td>
<td>CW</td>
<td>20 – 300</td>
</tr>
<tr>
<td>2</td>
<td>HC4</td>
<td>Physical Node</td>
<td>BIU 1</td>
<td>1</td>
<td>5</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>3</td>
<td>HC4</td>
<td>Physical Node</td>
<td>BIU 1</td>
<td>2</td>
<td>5</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>4</td>
<td>HC4</td>
<td>Physical Node</td>
<td>BIU 1</td>
<td>3</td>
<td>5</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>5</td>
<td>HC4</td>
<td>Physical Node</td>
<td>BIU 1</td>
<td>4</td>
<td>5</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>6</td>
<td>HC3</td>
<td>Physical Node</td>
<td>RMU 1</td>
<td>6</td>
<td>5</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>7</td>
<td>HC3</td>
<td>Physical Node</td>
<td>RMU 1</td>
<td>7</td>
<td>5</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>8</td>
<td>HC3</td>
<td>Physical Node</td>
<td>RMU 1</td>
<td>8</td>
<td>5</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>9</td>
<td>HC3</td>
<td>Modulation</td>
<td>RMU 1</td>
<td>5</td>
<td>5</td>
<td>Pulse</td>
<td>Up to 500</td>
</tr>
<tr>
<td>10</td>
<td>HC4</td>
<td>Position</td>
<td>BIU 1</td>
<td>1</td>
<td>1</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>11</td>
<td>HC4</td>
<td>Position</td>
<td>BIU 1</td>
<td>2</td>
<td>2</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>12</td>
<td>HC4</td>
<td>Position</td>
<td>BIU 1</td>
<td>3</td>
<td>3</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>13</td>
<td>HC4</td>
<td>Position</td>
<td>BIU 1</td>
<td>4</td>
<td>4</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>14</td>
<td>HC3</td>
<td>Position</td>
<td>RMU 1</td>
<td>6</td>
<td>6</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>15</td>
<td>HC3</td>
<td>Position</td>
<td>RMU 1</td>
<td>7</td>
<td>7</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>16</td>
<td>HC3</td>
<td>Position</td>
<td>RMU 1</td>
<td>8</td>
<td>8</td>
<td>CW</td>
<td>Up to 300</td>
</tr>
<tr>
<td>17</td>
<td>HC3</td>
<td>Modulation</td>
<td>RMU 1</td>
<td>5</td>
<td>5</td>
<td>Square wave</td>
<td>Up to 400</td>
</tr>
</tbody>
</table>

#### 5.5. Ranking of Nodes and Positions

The results of the HSTC will include the ranking of the physical nodes based on their average field strength susceptibility across the tested frequency range, and also the ranking of the chamber positions based on the average magnitude of the local field strength across the tested frequency range. Both of these ranking will only consider CW modulation tests. Since it is expected that the measured susceptibility threshold of multi-node ROBUS configurations will be dependent on the position assignment of the constituent nodes, the rankings of the physical nodes and positions will be used to try to predetermine the relative susceptibility threshold of the tested communication systems and thus make the comparison of relative fault handling effectiveness as fair as possible. It is known that the peak field intensity at a particular position inside the chamber is highly dependent on the relative alignment of the field stirrers, and that because of this the rankings of the tested nodes and positions based on observed susceptibility thresholds are not reliable. Nevertheless, this approach will be used as it provides a simple, methodical way of deciding how to position multiple nodes inside the chamber.

To enable the ranking of the positions by the local field strength and of the nodes by their
susceptibility to the field, a model has been developed that relates the nominal field strength in the chamber to the magnitude of the disturbance experienced by the internal electronic components of a node. The nominal field strength will be measured by a receive antenna at a fixed position separate from where the nodes will be placed. Although mode stirring will be used in this test, which provides a certain degree of spatial field uniformity, it is expected that the local peak field strength will be different for each of the identified test node positions. It is also expected that each node will have a slightly different susceptibility threshold with respect to the local peak field strength. Equation (3) incorporates these two factors determining the observed susceptibility threshold with respect to the nominal field strength.

\[ V^I = W^P \cdot W^S \cdot E \]  

(3)

Here, \( V^I \) is the disturbance voltage experienced by the internal electronic components of a node, \( W^P \) is a scaling factor that maps the nominal field strength to the local field strength at a given position, \( W^S \) is a scaling factor mapping the local field strength to the magnitude of the disturbance experienced internally by the electronic components of the node, and \( E \) is the nominal field strength. Factor \( W^S \) is inversely proportional to the shielding effectiveness of a node, such that a lower value of \( W^S \) corresponds to a more effective shielding of the node’s internal electronic components.

In using equation (3) to rank the nodes and positions, it is assumed that the internal electronic components of all the nodes have the same susceptibility threshold, such that all the nodes experience an upset at the same value of \( V^I \). Differences among the nodes in the value of factor \( W^S \) is assumed to be caused by slight variations in manufacturing and layout of the nodes, including wiring. Differences in the value of factor \( W^P \) are assumed to be due to limitations of the field stirring mechanism and positioning of the node.

Tests 1 through 8 in Table 2 will measure the nominal susceptibility threshold of the nodes at position 5. \( W^P \) is assumed constant for all those tests, and therefore, the differences in the measured susceptibility thresholds of the nodes are due to differences in the value of the \( W^S \) factor. Thus, ranking the nodes by their susceptibility threshold consists of sorting the values of their \( W^S \) factors. Equation (4), derived using equation (3) for two nodes, x and 5, will be used for this purpose.

\[ \frac{W^S_x}{W^S_5} = \frac{E^5_x}{E^5_5} \]  

(4)

Here, \( W^S_x \) is \( W^S \) for node x and \( W^S_5 \) is \( W^S \) for reference node 5. \( E^b_a \) is the nominal susceptibility threshold of node b at position a. Using equation (4) we can rank the nodes by their susceptibility relative to the susceptibility of node 5 using the measured nominal field strength susceptibility thresholds.

The results of tests 1 through 8 and 10 through 16 in Table 2, where each node is tested at reference position 5 and at one other position, will be used to rank the positions by the local field strength. Specifically, the positions will be ranked by the value of their \( W^P \) factors using the susceptibility thresholds measured at each position and at reference position 5 for a particular node. In this case, \( W^S \) is held constant and \( W^P \) varies. Applying equation (3) for position 5 and for some position y with the same node x, we can derive equation (5).

\[ \frac{W^P_y}{W^P_5} = \frac{E^y_x}{E^5_x} \]  

(5)

Here, \( W^P_y \) is \( W^P \) for position y and \( W^P_5 \) is \( W^P \) for reference position 5. From equation (5), a higher susceptibility threshold at position y corresponds to a lower value of scaling factor \( W^P_y \), which indicates
that the local field strength there is lower, as expected. Thus, with this expression we can sort the positions by their local field strength relative to the field strength at position 5 using the measured susceptibility thresholds.

To account for the various test frequencies in the HSTC, the final ranking of nodes and positions will be based on the average ranking for the set of tested frequencies.

5.6. HIRF Effects Characterization

Table 3 lists the tests for the HEC. As shown, low and high susceptibility threshold position assignments will be tested for each hardware configuration. For HC1 and HC2 configurations involving the simplex hub, a physical node and position assignment with average susceptibility threshold (i.e., approximately at the midpoint between the extremes) will also be tested.

For each of these tests and at each tested frequency, the field strength will be incremented first in steps of 20 V/m until the susceptibility threshold level is reached, and then a finer resolution of 10 V/m will be used to more accurately determine the susceptibility threshold. CW will be used for these phases. Once the threshold is determined for a particular test frequency, the HEC part of the test begins.

An HEC round consists of a series of discrete radiation exposures separated by intervals with no radiation. Each radiation exposure is called a strike, and each quiet interval after a strike is called a lull. Each strike will consist of 5 seconds of continuous unmodulated (CW) radiation. Each lull will also last for 5 seconds. The purpose for the lulls is to allow the targeted system to recover before the arrival of the next disturbance. Each HEC round will last for 200 seconds (i.e., 20 radiation strikes), and the field strength will increment in steps of 10 V/m between rounds. The stirrers will move at 5 seconds per revolution.

The actual test frequencies, field strength ranges, and the position assignments for targeted physical RSPP nodes will be selected based on the results of the HSTC tests. Due to time constraints, it is likely that not all the tests in Table 3 can be carried out. In that case, a subset will be selected taking into consideration time availability and the results of the HSTC tests.

Table 3: Tests for HIRF Effects Characterization

<table>
<thead>
<tr>
<th>Hardware Configuration</th>
<th>Number of Hardware Position Assignments (Expected relative susceptibility thresholds)</th>
</tr>
</thead>
<tbody>
<tr>
<td>HC1</td>
<td>3 (Low, Average, High)</td>
</tr>
<tr>
<td>HC2</td>
<td>3 (Low, Average, High)</td>
</tr>
<tr>
<td>HC3</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC4</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC5</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC6</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC7</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC8</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC9</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC10</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC11</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC12</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC13</td>
<td>2 (Low, High)</td>
</tr>
<tr>
<td>HC14</td>
<td>2 (Low, High)</td>
</tr>
</tbody>
</table>
6. Test Automation

The Test Control System (TCS) consists of three interconnected computers. The Test Controller controls the RF environment inside the test chamber and the power supply for the targeted components. The PE Emulator implements the PE, Hub Fault Analyzer, and Node Fault Analyzer functions, and monitors the operation of the communication system under test (SUT) at its interface. The Bus Monitor implements the SUT state monitoring function. Figure 9 shows the interconnection topology of the TCS. The Test Controller is the central element of this system, with the PE Emulator and Bus Monitor working as SUT monitoring controllers. The computers communicate via RS-232 serial links. Communication with the tested communication system (i.e., ROBUS or the simplex hub) is via fiber-optic links. A separate computer serves as a data repository and is connected to the PE Emulator and the Bus Monitor via a dedicated Ethernet network.

![Test Control System Topology](image)

Figure 9: Test Control System Topology

The PE Emulator and Bus Monitor computers are programmed with information about the hardware configuration being tested and the duration of a round, but they do not have information about the test sequences.

The TCS operates in rounds, with the field settings for each execution round corresponding to a point in a field-strength-by-frequency matrix. The execution of a round is enabled by the TCS operators, who are also responsible for monitoring the operation of the system during the round. Each computer is enabled independently. Once enabled, the computers automatically coordinate their actions during a round using the Controller Coordination Protocol (CCP). The CCP is a handshake protocol that enables the test control computers to execute a test round and provides exception-handling capability to ensure that the computers gracefully finish the execution of each round. The TCS operators serve as backup to deal with unexpected situations (e.g., a TCS computer crash).

A TCS execution round consists of two phases: SUT Check and SUT Test. In the SUT Check phase, the TCS powers up the SUT target components and confirms normal operation. The SUT Test phase is where the SUT target components are exposed to the test radiation environment. After the SUT Test phase is complete, the TCS saves the collected data and waits for operator authorization to begin the next round. The TCS execution ends after the last round of a HIRF test is complete.

Figure 10 shows an example of the flow of events for a normal execution of the CCP protocol. A
The basic assumption of the protocol is that for each round all the TCS computers are enabled within a time interval of known bounded duration. This is illustrated by the TCS Enable interval in Figure 10.

Figure 10: Typical event sequence for the CCP protocol

Description of events in Figure 10:

1. The PE Emulator is enabled by the operator and transitions from state WAIT_CONTINUE to state DELAY_READY.

2. The Bus Monitor is enabled by the operator and transitions from state WAIT_CONTINUE to state DELAY_READY.

3. The Test Controller is enabled by the operator and transitions from state WAIT_CONTINUE to state WAIT_READY.

4. The PE Emulator sends READY and transitions to state WAIT_READY_ECHO.

5. The Bus Monitor sends READY and transitions to state WAIT_READY_ECHO.

6. The Test Controller receives two READY messages.

7. After powering up the SUT target components, the Test Controller broadcasts READY and the Round Index, and then transitions to state WAIT_START.

8. When the PE Emulator receives READY and the Round Index, it enables the local SUT monitoring functions and transitions to state WAIT_SUT_STATUS.
9. When the Bus Monitor receives READY and the Round Index, it enables the local SUT monitoring functions and transitions to state WAIT_SUT_STATUS.

10. When the Bus Monitor confirms that the SUT is operating normally, it sends START and transitions to state WAIT_START_ECHO.

11. When the PE Emulator confirms that the SUT is operating normally, it sends START and transitions to state WAIT_START_ECHO.

12. When the Test Controller receives both START messages, it broadcasts START, starts a delay timer to begin the HIRF radiation, and transitions to state WAIT_HIRF_BEGIN.

13. When the PE Emulator receives START, it starts a round duration timer and begins collecting SUT execution data in state WAIT_ROUND_COMPLETION.

14. When the Bus Monitor receives START, it starts a round duration timer and begins collecting SUT execution data in state WAIT_ROUND_COMPLETION.

15. When the Test Controller’s HIRF delay timer expires, the radiation begins and the Test Controller transitions to state WAIT_HIRF_END.

16. The Test Controller ends the radiation and transitions to state WAIT_ROUND_CONTINUE.

17. When the PE Emulator’s round duration timer expires, it saves the collected data to the repository and transitions to state SAVE_DATA_RECORDS.

18. When the Bus Monitor’s round duration timer expires, it saves the collected data to the repository and transitions to state SAVE_DATA_RECORDS.

19. Round ends for the Test Controller, and it transitions to state ROUND_DECISION.

The READY, START, and STOP messages used in the CCP are mapped to RS-232 messages as indicated on Table 4.

<table>
<thead>
<tr>
<th>Table 4: CPP message encoding for RS-232 communication</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>CCP Message</strong></td>
</tr>
<tr>
<td></td>
</tr>
<tr>
<td>READY</td>
</tr>
<tr>
<td>START</td>
</tr>
<tr>
<td>STOP</td>
</tr>
</tbody>
</table>

The RS-232 links are configured as follows.

- **Baud Rate** 19200
- **Message Format** 8N1 (8-bit character, no parity, 1 stop bit)
- **Flow Control** Hardware
The transmission of the Round_Index variable by the Test Controller is implemented as three separate RS-232 messages, each carrying the ASCII code representation of a digit of the value of Round_Index (i.e., each digit is transmitted as a character). The most significant digit is transmitted first.

Table 5 lists execution variables used in the CCP process executed by the Test Controller. There are three test phases defined. During the HSTC test phase, the field strength will be incremented until the susceptibility threshold is reached. The FHSTC (Fine HSTC) test phase determines the susceptibility threshold with the finer field strength resolution. The HEC test phase executes the HEC long duration rounds at or above the susceptibility threshold. The following parameters are used in the definition of the CCP.

- **HSTC_Max_Field_Strength** = Maximum field strength for HSTC and FHSTC test phases
- **HEC_Num_Field_Levels** = Number of test field levels for HEC mode
- **N** = max (3, HEC_Num_Field_Levels)

As the central element of the TCS, the Test Controller is responsible for automatically creating a test log file. A test log entry is made after each round.

Table 5: Execution variables for the Test Controller CCP process

<table>
<thead>
<tr>
<th>Variable</th>
<th>Data Type</th>
<th>Data Range</th>
<th>Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td>Test_Phase</td>
<td>Enumerated</td>
<td>{HSTC, FHSTC, HEC}</td>
<td>For HSTC tests, HSTC is the only phase. For HEC tests, all the phases apply.</td>
</tr>
<tr>
<td>HSTCDone</td>
<td>Boolean</td>
<td>{FALSE, TRUE}</td>
<td>Flag asserted if no susceptibility is found up to HSTC_Max_Field_Strength</td>
</tr>
<tr>
<td>HEC_Done</td>
<td>Boolean</td>
<td>{FALSE, TRUE}</td>
<td>Flag asserted when HEC test phase is complete</td>
</tr>
<tr>
<td>Round_Index</td>
<td>Integer</td>
<td>000 - 999</td>
<td>Unique round identifier</td>
</tr>
<tr>
<td>Frequency</td>
<td>Real</td>
<td>100.0 - 1000.0 MHz</td>
<td>--</td>
</tr>
<tr>
<td>Field_Strength</td>
<td>Real</td>
<td>0.0 – 1000.0 V/m</td>
<td>--</td>
</tr>
<tr>
<td>HSTC_Fail_Field_Strength</td>
<td>Real</td>
<td>0.0 - 1000.0 V/m</td>
<td>--</td>
</tr>
<tr>
<td>Trial</td>
<td>Integer</td>
<td>1 - N</td>
<td>For 2-out-of-3 rule, and HEC test phase</td>
</tr>
<tr>
<td>Round_Result</td>
<td>Enumerated</td>
<td>{Abort, Pass, Fail}</td>
<td>Result of round</td>
</tr>
<tr>
<td>Test_Point_Decision</td>
<td>Enumerated</td>
<td>{None, Retry, Pass, Fail}</td>
<td>Decision for the test point.</td>
</tr>
</tbody>
</table>

Table 6 lists the timeout delays used in the Test Controller CCP process. Specific values for the CCP timeout delays will be empirically determined during the integration of the TCS computers.
Table 6: Timeout delays for the Test Controller CCP process

<table>
<thead>
<tr>
<th>Timeout</th>
<th>Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td>READY_Receive_Delay_Max</td>
<td>Maximum allowed delay for receiving the READY messages from the monitors after the Test Controller is enabled to execute a round.</td>
</tr>
<tr>
<td>START_Receive_Delay_Max</td>
<td>Maximum allowed delay to receive the START messages from the monitors after the READY echo is sent by the Test Controller.</td>
</tr>
<tr>
<td>HIRF_Begin_Delay</td>
<td>Delay by the Test Controller to start the radiation after sending the START echo message.</td>
</tr>
<tr>
<td>HSTC_Round_End_Delay</td>
<td>Time delay from the beginning of the radiation until the round is complete for the HSTC and FHSTC test phases.</td>
</tr>
<tr>
<td>HEC_Round_End_Delay</td>
<td>Time delay from the beginning of the radiation until the round is complete for the HEC test phase.</td>
</tr>
</tbody>
</table>

Figure 11 shows the rule for deciding what to do after the radiated target components experience errors at a given field strength and frequency test point. This is a 2-out-of-3 rule for confirming susceptibility at a given frequency and field strength. This rule applies to the HSTC and FHSTC test phases.

1. If a target-originated error is not detected during the first round, the target shall be tested at the next field strength level. If a target-originated error is detected during the first round, the round shall be repeated.

2. If a target-originated error is detected during the second round, susceptibility is confirmed. If a target-originated error is not detected during the second round, the round shall be repeated once more.

3. If a target-originated error is detected during the third round, susceptibility is confirmed. If a target-originated error is not detected during the third round, the target shall be tested at the next field strength level.

Figure 12 lists the CCP process for the Test Controller using pseudo-code and finite state machine (FSM) notation. This process is designed to always return the Test Controller, the RF equipment and the targeted devices inside the chamber to a safe state after every round. The test log files and the field measurements collected by the Test Controller are stored locally during testing and transferred to the repository afterward.

Figure 13 lists the CCP process for the PE Emulator and the Bus Monitor. After every round, the PE Emulator and the Bus Monitor automatically transfer their data files to the test data repository. This process is designed with an auto-continue feature by which the PE Emulator and the Bus Monitor automatically begin the next round if no abnormal conditions are detected by the end of a round. The Test Controller process does not have this feature and requires the operator to manually begin the next round. This combination simplifies and expedites the execution of the test, while allowing the operator to always maintain control and safety during the test.

Table 7 lists the timeout delays in the CCP process of the PE Emulator and the Bus Monitor. The
operator can select one of two available round duration delays, one for the HSTC and FHSTC test rounds and another for the HEC rounds.

Table 7: Timeout delays in the CCP process for the PE Emulator and the Bus Monitor

<table>
<thead>
<tr>
<th>Timeout</th>
<th>Comments</th>
</tr>
</thead>
<tbody>
<tr>
<td>READY_Send_Delay</td>
<td>Delay to send the READY message after the round execution is enabled</td>
</tr>
<tr>
<td>READY_Echo_Delay_Max</td>
<td>Maximum allowed delay to received the READY message echo from the Test Controller after sending the READY message</td>
</tr>
<tr>
<td>START_Echo_Delay_Max</td>
<td>Maximum allowed delay to received the START message echo from the Test Controller after sending the START message</td>
</tr>
<tr>
<td>Round_Completion_Delay_1</td>
<td>Option 1 for the duration of the round</td>
</tr>
<tr>
<td>Round_Completion_Delay_2</td>
<td>Option 2 for the duration of the round</td>
</tr>
</tbody>
</table>
Figure 12: CCP Process for the Test Controller

Initialize: Round_Index, Frequency, Field_Strength, Trial, Max_HSTC_Field_Strength
Open log file
Test_Phase = HSTC
HSTC_Done = FALSE
HEC_Done = FALSE
Previous_Round_Stopped = TRUE
Current_State = WAIT_CONTINUE
Power down SUT target components
FSM(Current_State)

WAIT_CONTINUE:
if (Operator_Input = DONE) or (HSTC_Done = TRUE) or (HEC_Done = TRUE),
Close log file
Exit
elsif (Operator_Input = CONTINUE),
Set up test equipment for round: Frequency, Field_Strength, Strike Pattern
if (Previous_Round_Stopped = TRUE)
Clear PE_Emulator_Message and Bus_Monitor_Message buffers
end if
Previous_Round_Stopped = TRUE
Start Timeout1(READY_Receive_Delay_Max)
Current_State = WAIT_READY
else
Current_State = WAIT_CONTINUE
end if

WAIT_READY:
if (Operator_Input = STOP) or (Timeout1) or
((PE_Emulator_Message != no_message) and
(PE_Emulator_Message != READY)) or
((Bus_Monitor_Message != no_message) and
(Bus_Monitor_Message != READY)),
Broadcast STOP message
Round_Result = Abort
Current_State = ROUND_DECISION
elsif (PE_Emulator_Message = READY) and
(Bus_Monitor_Message = READY),
Power up SUT target components
Broadcast READY message
Broadcast Round_Index
Start Timeout2(START_Receive_Delay_Max)
Current_State = WAIT_START
else
Current_State = WAIT_READY
end if

WAIT_START:
if (Operator_Input = STOP) or (Timeout2) or
((PE_Emulator_Message != no_message) and
(PE_Emulator_Message != START)) or
((Bus_Monitor_Message != no_message) and
(Bus_Monitor_Message != START)),
Broadcast STOP message
Round_Result = Abort
Current_State = ROUND_DECISION
elsif (PE_Emulator_Message = START) and (Bus_Monitor_Message = START),
    Broadcast START message
    Start Timeout3(HIRF_Begin_Delay)
    Current_State = WAIT_HIRF_BEGIN
else
    Current_State = WAIT_START
end if

WAIT_HIRF_BEGIN:
if (Operator_Input = STOP) or
   (PE_Emulator_Message != no_message) or
   (Bus_Monitor_Message != no_message),
    Broadcast STOP message
    Round_Result = Abort
    Current_State = ROUND_DECISION
elsif (Timeout3),
    Begin HIRF Radiation
    If (Test_Phase = HEC)
        Start Timeout4(HEC_Round_End_Delay)
    else
        Start Timeout4(HSTC_Round_End_Delay)
    end if
    Current_State = WAIT_HIRF_END
else
    Current_State = WAIT_HIRF_BEGIN
end if

WAIT_HIRF_END:
if (Operator_Input = STOP),
    End HIRF radiation
    Broadcast STOP message
    Round_Result = Abort
    Current_State = ROUND_DECISION
elsif (PE_Emulator_Message != no_message) or
   (Bus_Monitor_Message != no_message),
    End HIRF radiation
    Broadcast STOP message
    Round_Result = Fail
    Current_State = ROUND_DECISION
elsif ((Test_Phase = HEC) and (HEC HIRF Round Finished)) or
   ((Test_Phase != HEC) and (HSTC HIRF Round Finished))
    End HIRF radiation
    Current_State = WAIT_ROUND_END
else
    Current_State = WAIT_HIRF_END
end if

WAIT_ROUND_END:
if (Operator_Input = STOP),
    Broadcast STOP message
    Round_Result = Abort
    Current_State = ROUND_DECISION
elsif (PE_Emulator_Message != no_message) or
    (Bus_Monitor_Message != no_message),
Broadcast STOP message
Round_Result = Fail
Current_State = ROUND_DECISION
elsif (Timeout4),
    Previous_Round_Stopped = FALSE
Round_Result = Pass
Current_State = ROUND_DECISION
else
    Current_State = WAIT_ROUND_END
end if

ROUND_DECISION:
if (Round_Result != Pass),
    Power down SUT target components
end if

// Test Point, Field Strength, and Test Phase Decision
if (Test_Phase = HSTC) or (Test_Phase = FHSTC),
// Test Point Decision for HSTC and FHSTC (2-out-of-3 rule)
if (Round_Result = Abort),
    Test_Point_Decision = None
else
    if (Trial = 1),
        if (Round_Result = Pass),
            Test_Point_Decision = Pass
        else
            Test_Point_Decision = Retry
        end if
    elsif (Trial = 2),
        if (Round_Result = Pass),
            Test_Point_Decision = Retry
        else
            Test_Point_Decision = Fail
        end if
    else
        if (Round_Result = Pass),
            Test_Point_Decision = Pass
        else
            Test_Point_Decision = Fail
        end if
    end if

// Make log file entry
Log file entry: Round_Index, Frequency, Field_Strength, Trial,
    Round_Result, Test_Point_Decision, Test_Phase

// Set Trial number and Round Index
if (Test_Point_Decision = Pass) or (Test_Point_Decision = Fail),
    Trial = 1
Round_Index ++
elsif (Test_Point_Decision = Retry)
    Trial ++
    Round_Index ++
end if

// Decide next Test_Phase and Field_Strength
if (Test_Phase = HSTC) and (Test_Point_Decision = Pass),
    if (Field_Strength = HSTC_Max_Field_Strength),
        HSTC_Done = TRUE
    else
        Field_Strength = HSTC_Next_Field_Strength(Field_Strength)
    end if
elsif (Test_Phase = HSTC) and (Test_Point_Decision = Fail),
    // Save current HSTC field strength
    HSTC_Fail_Field_Strength = Field_Strength
    // Get first FHSTC field strength
    Field_Strength = FHSTC_First_Field_Strength(Field_Strength)
    // Go to FHSTC Phase
    Test_Phase = FHSTC
elsif (Test_Phase = FHSTC) and (Test_Point_Decision = Pass),
    // Get next FHSTC field strength
    Field_Strength = FHSTC_Next_Field_Strength(Field_Strength)
    // If next FHSTC field strength is equal to the latest one of HSTC
    // (with test point decision of Fail), do not retest there and go directly to HEC
    if (Field_Strength = HSTC_Fail_Field_Strength),
        Field_Strength = HEC_First_Field_Strength(HSTC_Fail_Field_Strength)
        Test_Phase = HEC
    end if
elsif (Test_Phase = FHSTC) and (Test_Point_Decision = Fail),
    // Get first HEC test point and go to HEC phase
    Field_Strength = HEC_First_Field_Strength(Field_Strength)
    Test_Phase = HEC
end if
else
    // For HEC
    // Test Point Decision
    if (Round_Result = Abort),
        Test_Point_Decision = None
    elsif (Round_Result = Pass),
        Test_Point_Decision = Pass
    else
        Test_Point_Decision = Fail
    end if
// Make log file entry
Log file entry: Round_Index, Frequency, Field_Strength, Trial,
Round_Result, Test_Point_Decision, Test_Phase

// Decide next Test_Phase and Field Strength
if (Test_Point_Decision != None)
  if (Trial = HEC_Num_Field_Levels),
    // Done with HEC.
    HEC_Done = TRUE
    Trial = 1
    Round_Index ++
  else
    // Continue with HEC
    Trial ++
    Round_Index ++
    Field_Strength = HEC_Next_Field_Strength(Field_Strength)
  end if
end if

Current_State = WAIT_CONTINUE
Figure 13: CCP Process for the PE Emulator and the Bus Monitor

Load local SUT-interface functions
Auto_Continue = FALSE
Current_State = WAIT_CONTINUE
FSM(Current_State)

WAIT_CONTINUE:
  if (Auto_Continue = FALSE) and
    if (Operator_Input = DONE),
      Exit
  elsif (Operator_Input = CONTINUE_1) or (Operator_Input = CONTINUE_2),
    Disable and reset local SUT-interface functions
    Clear Test_Controller_Message buffer
    Auto_Continue = FALSE
    if (Operator_Input = CONTINUE_1)
      Round_Completion_Delay = Round_Completion_Delay_1
    else
      Round_Completion_Delay = Round_Completion_Delay_2
    end if
    Start Timeout1(READY_Send_Delay)
    Current_State = WAIT_SEND_READY
  else
    Current_State = WAIT_CONTINUE
  end if
else
  Disable and reset local SUT-interface functions
  Auto_Continue = FALSE
  Start Timeout1(READY_Send_Delay)
  Current_State = WAIT_SEND_READY
end if

WAIT_SEND_READY:
  if (Operator_Input = STOP) or (Test_Controller_Message != no_message),
    Send STOP message
    Current_State = WAIT_CONTINUE
  elsif (Timeout1),
    Send READY message
    Start Timeout2(READY_Echo_Delay_Max)
    Current_State = WAIT_READY_ECHO
  else
    Current_State = DELAY_READY
  end if

WAIT_READY_ECHO:
  if (Operator_Input = STOP) or
    ((Test_Controller_Message != no_message) and
     (Test_Controller_Message != READY)) or
    (Timeout2),
    Send STOP message
    Current_State = WAIT_CONTINUE
  end if
Figure 13: CCP Process for the PE Emulator and the Bus Monitor (continued)

```plaintext
elsif (Test_Controller_Message = READY),
    Current_State = WAIT_ROUND_INDEX
else
    Current_State = WAIT_READY_ECHO
end if

WAIT_ROUND_INDEX:
if (Operator_Input = STOP) or
   ((Test_Controller_Message != no_message) and
    (Test_Controller_Message != valid_round_index)) or
   (Timeout2),
   Send STOP message
   Current_State = WAIT_CONTINUE
elsif (Test_Controller_Message = valid_round_index),
   Set Round_Index = Test_Controller_Message
   Enable local SUT-interface functions
   Begin collection of SUT data records
   Current_State = WAIT_SUT_STATUS
else
    Current_State = WAIT_ROUND_INDEX
end if

WAIT_SUT_STATUS:
if (Operator_Input = STOP) or (Test_Controller_Message != no_message) or
   (SUT_Status = FAILED),
   End collection of SUT data records
   Send STOP message
   Current_State = SAVE_DATA_RECORDS
elsif (SUT_Status = TRUSTED),
   Send START message
   Start Timeout3(START_Echo_Delay_Max)
   Current_State = WAIT_START_ECHO
else
    Current_State = WAIT_SUT_STATUS
end if

WAIT_START_ECHO:
if (Operator_Input = STOP) or
   ((Test_Controller_Message != no_message) and
    (Test_Controller_Message != START)) or
   (SUT_Status != TRUSTED) or (Timeout3),
   End collection of SUT data records
   Send STOP message
   Current_State = SAVE_DATA_RECORDS
elsif (Test_Controller_Message = START),
   Discard accumulated SUT data records
   Start Timeout4(Round_Completion_Delay)
   Current_State = WAIT_ROUND_COMPLETION
else
    Current_State = WAIT_START_ECHO
end if
```
7. Health Checks

Each hardware configuration HIRF test will be preceded and followed by a hardware configuration Health Check consisting of a two-hour run without radiation. A Health Check will also be performed after every change to the hardware components of the tested hardware configuration. The purpose of these checks is to confirm that the system is operating properly before a HIRF test and to expose any damage caused by the radiation. The health checks provide assurance that errors detected during a HIRF test are due to the effect of the field on the targeted components and not due to the monitoring system or SUT components outside the radiation chamber.

8. Shielding and Grounding

Figure 14 shows a RSPP node in its normal configuration when placed outside the test chamber. The enclosure is made of aluminum, and the endcaps are attached to the extrusion via metal screws. Power is delivered to the node by a shielded power cable grounded at the source end. The power cable shield is electrically attached to the connector at the node, thus grounding the enclosure. The optical fibers and the power cable are the only external connections.
9. Equipment Layout

Figures 16 to 22 show the test setups for all the hardware configurations. The PE Emulator, Bus Monitor, and all the nodes inside the Control Room will receive 24V DC power from individual power supplies connected to standard AC wall outlets. The nodes inside Chamber A will receive 24V DC power from a power source controlled by the Test Controller. In order to minimize the distortion to the field characteristics experienced by the nodes inside Chamber A, the nodes will be separated from each other, from the chamber walls, floor and ceiling, and from any other metallic objects by at least 1.5 m (i.e., one
half wavelength at the lowest test frequency). The targeted nodes inside Chamber A will be placed on top of foam blocks or tables to provide support and ensure separation from the chamber floor.

![Test Setup for Hardware Configurations HC1 and HC2](image1.png)

Figure 16: Test Setup for Hardware Configurations HC1 and HC2

![Test Setup for Hardware Configurations HC3 and HC6](image2.png)

Figure 17: Test Setup for Hardware Configurations HC3 and HC6
Figure 18: Test Setup for Hardware Configurations HC4 and HC7

Figure 19: Test Setup for Hardware Configurations HC5 and HC8
Figure 20: Test Setup for Hardware Configurations HC9 and HC12

Figure 21: Test Setup for Hardware Configurations HC10 and HC13
Figure 22: Test Setup for Hardware Configurations HC11 and HC14
References


## Acronyms

<table>
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<tr>
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<th>Definition</th>
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<tbody>
<tr>
<td>ASCII</td>
<td>American Standard Code for Information Interchange</td>
</tr>
<tr>
<td>BIU</td>
<td>Bus Interface Unit</td>
</tr>
<tr>
<td>CCP</td>
<td>Controller Coordination Protocol</td>
</tr>
<tr>
<td>COTS</td>
<td>Commercial Off-The-Shelf</td>
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<tr>
<td>CPU</td>
<td>Central Processing Unit</td>
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<tr>
<td>CW</td>
<td>Continuous Wave</td>
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<tr>
<td>DC</td>
<td>Direct Current</td>
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<tr>
<td>DSI</td>
<td>Derivation Systems, Inc.</td>
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<tr>
<td>EM</td>
<td>Electromagnetic</td>
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<tr>
<td>EMI</td>
<td>Electromagnetic Interference</td>
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<tr>
<td>FHSTC</td>
<td>Fine HIRF Susceptibility Threshold Characterization</td>
</tr>
<tr>
<td>FPGA</td>
<td>Field Programmable Gate Array</td>
</tr>
<tr>
<td>FSM</td>
<td>Finite State Machine</td>
</tr>
<tr>
<td>HEC</td>
<td>HIRF Effects Characterization</td>
</tr>
<tr>
<td>HFA</td>
<td>Hub Fault Analyzer</td>
</tr>
<tr>
<td>HIRF</td>
<td>High Intensity Radiated Field</td>
</tr>
<tr>
<td>HSTC</td>
<td>HIRF Susceptibility Threshold Characterization</td>
</tr>
<tr>
<td>IVHM</td>
<td>Integrated Vehicle Health Management</td>
</tr>
<tr>
<td>LUF</td>
<td>Lowest Usable Frequency</td>
</tr>
<tr>
<td>Mbps</td>
<td>Mega-bits per second</td>
</tr>
<tr>
<td>NFA</td>
<td>Node Fault Analyzer</td>
</tr>
<tr>
<td>NIST</td>
<td>National Institute of Standards and Technology</td>
</tr>
<tr>
<td>PE</td>
<td>Processing Element</td>
</tr>
<tr>
<td>RC</td>
<td>Reverberation Chamber</td>
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<tr>
<td>RF</td>
<td>Radio Frequency</td>
</tr>
<tr>
<td>RMU</td>
<td>Redundancy Management Unit</td>
</tr>
<tr>
<td>ROBUS</td>
<td>Reliable Optical Bus</td>
</tr>
<tr>
<td>RPP</td>
<td>ROBUS Protocol Processor</td>
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<tr>
<td>RSPP</td>
<td>Reconfigurable SPIDER Prototyping Platform</td>
</tr>
<tr>
<td>RTCA</td>
<td>Radio Technical Commission for Aeronautics</td>
</tr>
<tr>
<td>SBIR</td>
<td>Small Business Innovation Research</td>
</tr>
<tr>
<td>SHM</td>
<td>System Health Monitor</td>
</tr>
<tr>
<td>SPIDER</td>
<td>Scalable Processor-Independent Design for Extended Reliability</td>
</tr>
<tr>
<td>SUT</td>
<td>System Under Test</td>
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<tr>
<td>TCS</td>
<td>Test Control System</td>
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<tr>
<td>TDMA</td>
<td>Time Division Multiple Access</td>
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Plan for the Characterization of HIRF Effects on a Fault-Tolerant Computer Communication System

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This report presents the plan for the characterization of the effects of high intensity radiated fields on a prototype implementation of a fault-tolerant data communication system. Various configurations of the communication system will be tested. The prototype system is implemented using off-the-shelf devices. The system will be tested in a closed-loop configuration with extensive real-time monitoring. This test is intended to generate data suitable for the design of avionics health management systems, as well as redundancy management mechanisms and policies for robust distributed processing architectures.

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